



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Takashi ABE

Appln. No.: 09/685,771

Confirmation No.: (Not yet assigned)

Group Art Unit: 2841

Filed: October 11, 2000

Examiner: I. Patel

For: CIRCUIT BOARD

TECHNOLOGICAL CENTER 2000
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AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated September 20, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

Please cancel claims 2, 3, 11, and 12 without prejudice or disclaimer.

Please enter the following amended claims:

1. (Amended) A substrate comprising:

pads which are provided on the surface of said substrate;

surface layers which are kept to the ground potential and cover the surface of said

substrate except said pads and their periphery, wherein said surface layers include a top main surface and a bottom main surface; and

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